The IEEE World Haptics Conference 2013

5th Joint Eurohaptics Conference and IEEE Haptics Symposium

IEEEWHC2013



SPONSORSHIP PROSPECTUS



Dear Colleagues,

On behalf of the IEEE WHC 2013 Organizing and Steering Committee, I would like to welcome you to the IEEE World Haptics Conference 2013, the 5th Joint Eurohaptics Conference and the IEEE Haptics Symposium (IEEE WHC 2013). As the general chair of the conference, it is my great pleasure and honor to invite you to the IEEE WHC 2013 in Daejeon, Korea, on April 14 ~ 17, 2013.

The IEEE WHC 2013 will offer opportunities to share the most up-to-date scientific discoveries and innovative products. The ultimate objective is to advance our field of haptics through networking among academia, industries, and all affiliated specialists and building mutual understanding among colleagues from all over the world.

The scientific programs will be provided all participants with opportunities to exchange the latest information, ideas, and experiences on haptic fields. Your important contributions of papers and poster presentations as well as active participation in workshops will make the events even more fruitful. Invaluable instructional lectures, workshops and tutorial statements will be offered from outstanding haptic experts.

A special industry session will be organized for this conference. The global IT industry leaders will be invited to talks and their recent findings as well as business insights will be exchanged through the industry session and exhibition.

I truly hope that you will take this chance to join us in Daejeon, to benefit from these grand events, and to plunge into the wonders of the traditional cultures and customs in this hidden jewel of Asia. Great weather and delicious cuisine mixed with friendly faces and warm welcomes await you.

I am looking forward to meeting you in Daejeon on April 14 $^{\sim}$ 17, 2013. With your active participation and support, this conference will achieve a resounding success. I assure you that this conference will be an academically enriching, socially enjoyable, and truly memorable experience for all delegates and accompaniers.

Thank you very much.

Sincerely,

Dong-Soo Kwon, Ph.D. General Chair of WHC 2013





General Information

(1) Conference Title

IEEE World Haptics Conference 2013, The 5th Joint Eurohaptics Conference and IEEE Haptics Symposium (IEEE WHC 2013)

(2) Conference Date

April 14 (Sun.) ~ 17 (Wed.), 2013

(3) Venue

Daejeon Convention Center (DCC), Daejeon, Korea

(4) Organized by

- Sponsor

IEEE Robot & Automation Society
Korea Robotics Society

- Technical Co-Sponsor

IEEE Technical Committee on Haptics

Eurohaptics Society

Korea Haptics Community

(5) Expected Number of Participants

About 400 persons

(6) Topics

- Haptic Interface Design & Control
- Tactile Display
- Sensors and Actuators
- Haptic Interaction & Design
- Teleoperation and Virtual Environments
- Haptic Rendering
- Shared Haptic Control and Collaboration
- Special Topic
- Haptics in Industry

- Human Haptic Perception
- Neurohaptics
- Biomechanics and Motor Control
- Affective Haptics
- Haptics in Industrial Applications
- Haptics in Mobile Devices
- Other Innovative Applications of Haptics
- Haptics in Art



(7) Organizing Committee

General Chair		Dong-Soo Kwon (KAIST, Korea)
O. C.	Editor-in-Chief	Hong Z. Tan (Microsoft Research Asia, China / Purdue University, USA)
Conference Editorial Board	Editor	Hiroyuki Shinoda (University of Tokyo, Japan)
	Editor	Miguel A. Otaduy (URJC Madrid, Spain)
Special	Co-Chair	Munchae Chung (LG Electronics, Korea)
Industry Session	Co-Chair	Jeha Ryu (GIST, Korea)
Poster Session	Chair	Sang-Youn Kim (Korea Univ. of Tech. and Education, Korea)
B	Co-Chair	Hiroyuki Kajimoto (Univ. of Electro-Communications, Japan)
Demonstration	Co-Chair	Jee-Hwan Ryu (Korea Univ. of Tech. and Education, Korea)
Industry Exhibition	Chair	Jinung An (DGIST, Korea)
Art Exhibition	Chair	Andrea Bianchi (KAIST, Korea)
Manhahan O Tatawial	Co-Chair	Angelika Peer (Technische Universität München, Germany)
Workshop & Tutorial	Co-Chair	Ian Oakley (Universidade da Madeira, Portugal)
	Chair	J. Edward Colgate (Northwestern Univ., USA)
Award Committee	Co-Chair	Vincent Hayward (Univ. Pierre et Marie Curie, France)
Award Committee	Co-Chair	Lynette A. Jones (MIT, USA)
	Co-Chair	Jung Kim (KAIST, Korea)
Dublication	Co-Chair	Seungmoon Choi (POSTECH, Korea)
Publication	Co-Chair	Jinah Park (KAIST, Korea)
Lacal Assessment	Co-Chair	Ki-Uk Kyung (ETRI, Korea)
Local Arrangement	Co-Chair	Eun-Sook Jee (KAIST, Korea)
	Co-Chair	Richard Adams (Barron Associates, Inc, USA)
	Co-Chair	Kwangsu Cho (Sungkyunkwan Univ., Korea)
Publicity	Co-Chair	Matthias Harders (ETH Zurich, Switzerland)
	Co-Chair	Dangxiao Wang (Beihang Univ., China)
	Co-Chair	Yasuyoshi Yokokohji (Kobe Univ., Japan)
Web	Chair	Gi-Hun Yang (KITECH, Korea)
Finance	Chair	Junseok Park (ETRI, Korea)
Secretariat	Chair	Tae-Heon Yang (KRISS, Korea)



(8) Registration (Member: IEEE Member, IEEE TCH Member, Eurohaptics Society Member, KROS Member)

Conference Registration Foo	Advance Registration	On-Site Registration
Conference Registration Fee	(Before March 1, 2013)	(After March 2, 2013)
Member	\$ 550	\$ 750
Non-Member	\$ 650	\$ 850
Student Member	\$ 350	\$ 500
Student Non-Member	\$ 400	\$ 550

It will be available to check the detailed information for registration via our official website, www.haptics2013.org.

(9) Key Miles for Sponsorship and Exhibition

November 20, 2012

Deadline for application submission to guarantee inclusion in printed conference materials

November 30, 2012

Deadline for application submission and full payment

January 5, 2013

Space assignments mailed (for exhibitors)

January 14, 2013

No refunds for cancellation

(10) Contacts

Industry Exhibition Chair

Jinung An (DGIST, Korea, robot@dgist.ac.kr)

Demonstration Co-Chairs

Hiroyuki Kajimoto (Univ. of Electro-Communications, Japan, kajimoto@hc.uec.ac.jp)

Jee-Hwan Ryu (Korea Univ. of Technology and Education, Korea, jhryu@kut.ac.kr)

Local Arrangement Co-Chairs

Ki-Uk Kyung (ETRI, Korea, kyungku@etri.re.kr)

Eun-Sook Jee (KAIST, Korea, esjee@kaist.ac.kr)

Finance Chair

Junseok Park (ETRI, Korea, parkjs@etri.re.kr)

General Chair

Dong-Soo Kwon (KAIST, Korea, kwonds@kaist.ac.kr)



Sponsorship Information

LEVEL	BENEFI	TS	VALUE
	Event Sponsorship	- Conference Banquet	
Diamond	 Four (4) complementary regular reg Acknowledgement in the program, Advertisement of the company on the Logo and web link on the conference Logo featured on newsletter mailed Individual banner on conference sit 2 free exhibit booths 	\$20,000 (KRW 20,000,000)	
Platinum	Event Sponsorship	- Welcome Reception - Farewell Party - Conference Kit	
	 Two (2) complementary regular reg Acknowledgement in the program, Advertisement of the company on the Logo and web link on the conference Logo featured on newsletter mailed Individual banner on conference site 2 free exhibit booths 	\$10,000 (KRW 10,000,000)	
	Event Sponsorship	- Lunch - Coffee Break - Awards	
Gold	 Two (2) complementary regular reg Acknowledgement in the program, Advertisement of the company on a Logo and web link on the conference Logo featured on newsletter mailed Individual banner on conference sit 1 free exhibit booth 	\$5,000 (KRW 5,000,000)	
	Event Sponsorship	- Coffee Break - Awards	
Silver	 One (1) complementary regular reg Acknowledgement in the program, Advertisement of the company on a Logo and web link on the conference Logo featured on newsletter mailed Individual banner on conference sit 1 free exhibit booth 	\$3,000 (KRW 3,000,000)	
Bronze	 Acknowledgement in the program, Advertisement of the company logo Logo and web link on the conference Logo featured on newsletter mailed Group banner on conference site 1 free exhibit booth 	o on the program book ce website (Bronze area)	\$2,000 (KRW 2,000,000)



Exhibition only

(1) Participation Fee

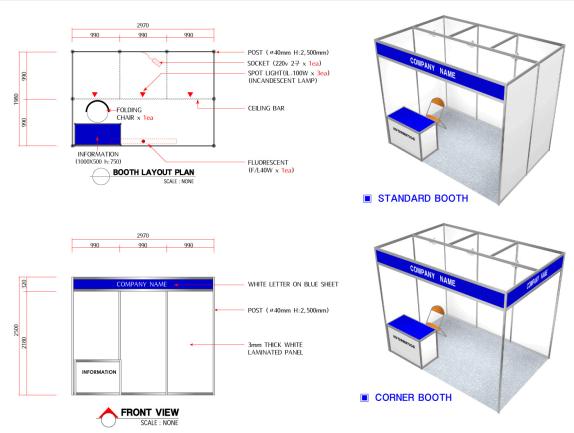
- One Standard Booth (3m *2m): \$2,000 per unit
- Two Standard Booths (6m * 2m): \$3,500 per unit

(2) Benefit for exhibitors

- One complementary regular registration per booth

(3) Booth Scheme

Shell Scheme Booth (3m x 2m)





Sponsorship Application Form

Company Information

* Please type company name as it should be published.

■ Company Name		
■ Contact Name		
■ Department	■ Title	
■ Address		
■ Zip Code	■ Country	
■ Tel	■ Fax	
■ E-mail	■ Mobile	

Sponsorship Item

- Please confirm our sponsorship as follows and tick applicable sponsorship item.

Sponsorship Categories		
Diamond Sponsor	\$20,000 (KRW 20,000,000)	
Platinum Sponsor	\$10,000 (KRW 10,000,000)	
Gold Sponsor	\$5,000 (KRW 5,000,000)	
Silver Sponsor	\$3,000 (KRW 3,000,000)	
Bronze Sponsor	\$2,000 (KRW 2,000,000)	
Exhibition (3m *2m)	\$2,000 (KRW 2,000,000)	
Exhibition (6m * 2m)	\$3,500 (KRW 3,500,000)	
Total		

Payment Method (choose one)

□ By Bank Transfer

-			
-	Account Holde	er:	Korea Robotics Society
-	Account Numb	oer	: 1005-601-320226
-	Bank Name	:	Woori Bank
-	SWIFT Code	:	HVBKKRSEXXX
-	Bank Address	: 5	1 Sogong-ro(Hoehyeon-dong 1-ga), Jung-gu, Seoul 100-792, Korea
Ву	Credit Card		

Name of Card holder:

- Signature: Date:

Terms of Payment:

 Full payment is due by Feb. 28, 2013 (Feb. 15, 2013 if Exhibitor wants to be included in printed proceedings as a sponsor) and must accompany this application. Notification of assignment of optional exhibit space will be mailed March 1, 2013.



- Due to continuous promotion of the conference and its supporters, conference support is not refundable.

Return Application and Full Payment to:

IEEE WHC 2013 Secretariat

Tel: +82-42-472-7460/ Fax: +82-42-472-7459 /E-mail: secretariat@haptics2013.org

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